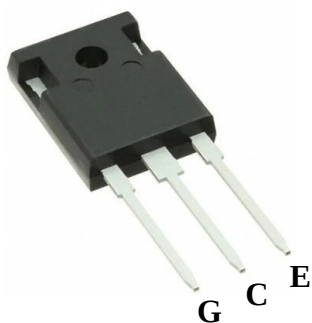
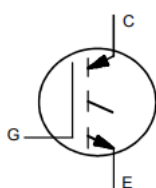




IGBT Discrete

V_{CE}	1200	V
I_C	80	A
$V_{CE(SAT)} I_C=80A$	1.75	V

Circuit



Applications

- PTC

Features

- High breakdown voltage to 1200V for improved reliability
- Maximum junction temperature 150°C
- Positive temperature coefficient
- Qualified to AEC-Q101

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-Emitter Breakdown Voltage	V_{CE}	1200	V
DC Collector Current, limited by T_{jmax} $T_C=25^{\circ}C$ $T_C=100^{\circ}C$	I_C	145* 80	A
Continuous Gate-Emitter Voltage	V_{GE}	± 20	V
Transient Gate-Emitter Voltage ($t_p \leq 10\mu s, D < 0.010$)	V_{GE}	± 30	V
Turn off Safe Operating Area $V_{CE} \leq 1200V$, $T_j \leq 150^{\circ}C$		240	A
Pulsed Collector Current, $V_{GE}=15V$, t_p limited by T_{jmax}	I_{CM}	240	A
Power Dissipation, $T_j=150^{\circ}C$, $T_C=25^{\circ}C$	P_{tot}	521	W

*Bond wire current limit is 80A



Operating Junction Temperature	T_j	-40...+150	°C
Storage Temperature	T_s	-55...+150	°C
Soldering Temperature, wave soldering 1.6mm (0.063in.) from case for 10s		260	°C

Electrical Characteristics of the IGBT ($T_j = 25^\circ\text{C}$ unless otherwise specified):

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Static						
Collector-Emitter Breakdown Voltage	BV_{CES}	$V_{GE}=0V, I_C=1mA$	1200		-	V
Gate Threshold Voltage	$V_{GE(th)}$	$V_{GE}=V_{CE}, I_C=2.6mA$	5.35	6.0	6.7	V
Collector-Emitter Saturation Voltage	$V_{CE(sat)}$	$V_{GE}=15V, I_C=80A$ $T_j=25^\circ\text{C}$, $T_j=125^\circ\text{C}$ $T_j=150^\circ\text{C}$	1.45	1.75 2.15 2.25	2.30	V
Zero Gate Voltage Collector Current	I_{CES}	$V_{CE}=1200V, V_{GE}=0V$ $T_j=25^\circ\text{C}$, $T_j=150^\circ\text{C}$			0.25 1.00	mA
Gate-Emitter Leakage Current	I_{GES}	$V_{CE}=0V, V_{GE}=\pm 20V$			± 100	nA

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic						
Input Capacitance	C_{ies}	$V_{CE}=25V, V_{GE}=0V$, $f=1MHz$	-	7.95	-	nF
Reverse Transfer Capacitance	C_{res}		-	0.19	-	
Gate Charge	Q_G	$V_{CC}=960V, I_C=80A$, $V_{GE}=15V$	-	0.65	-	uC

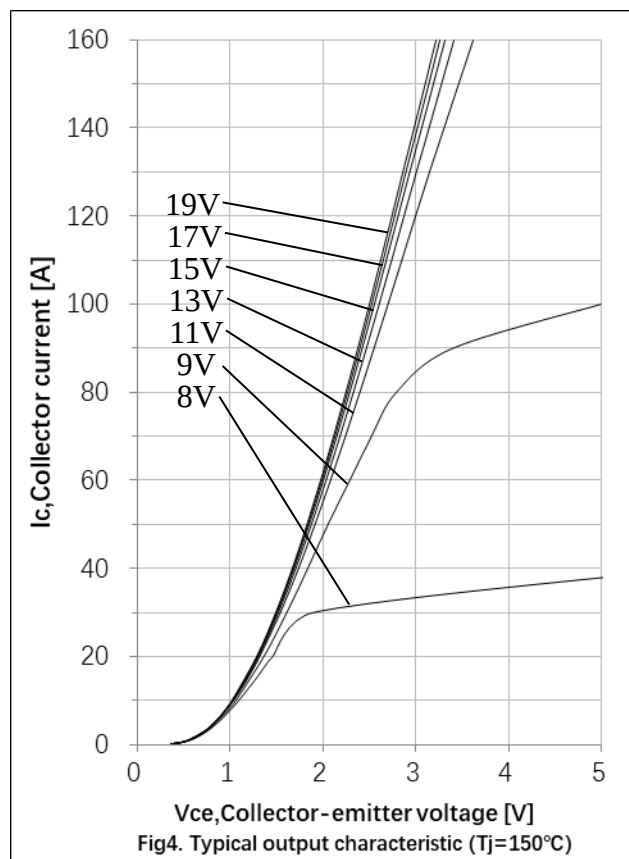
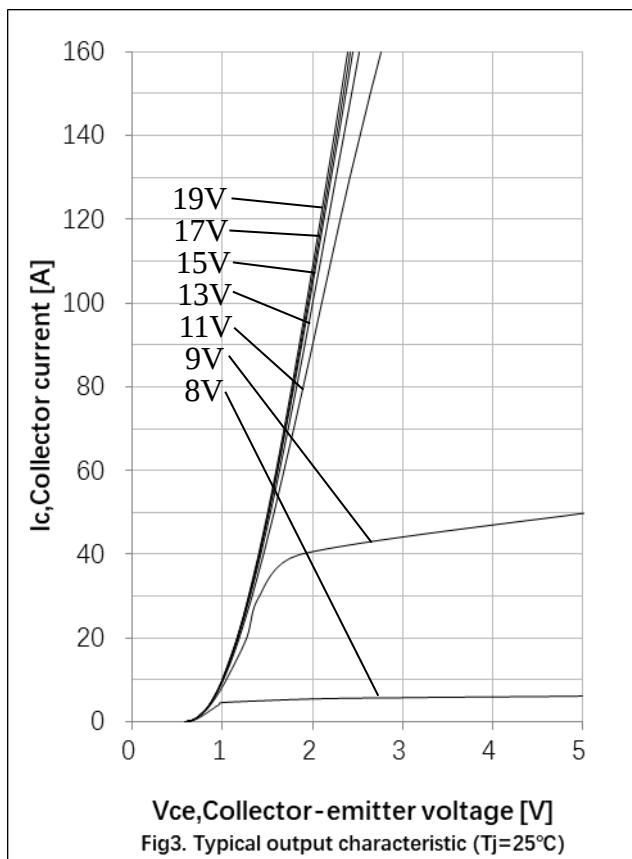
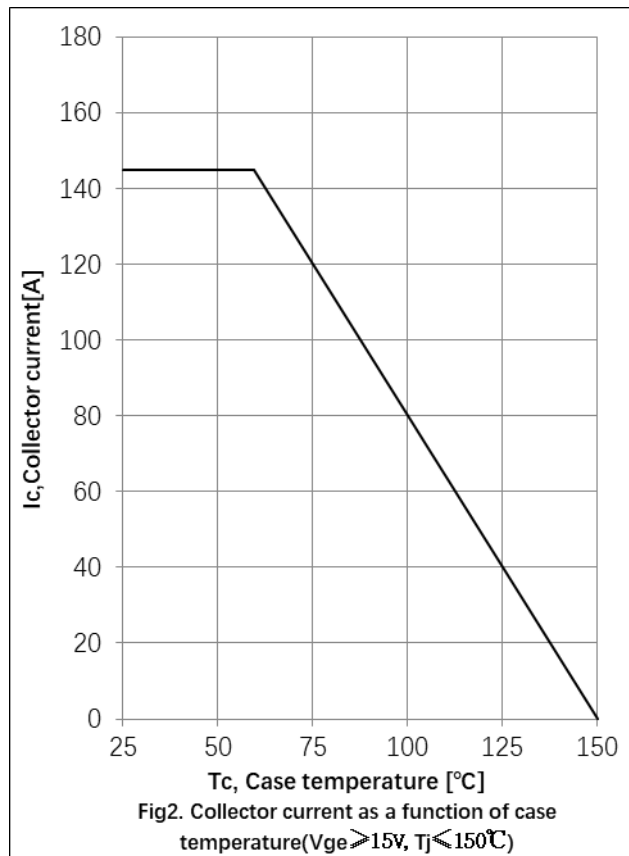
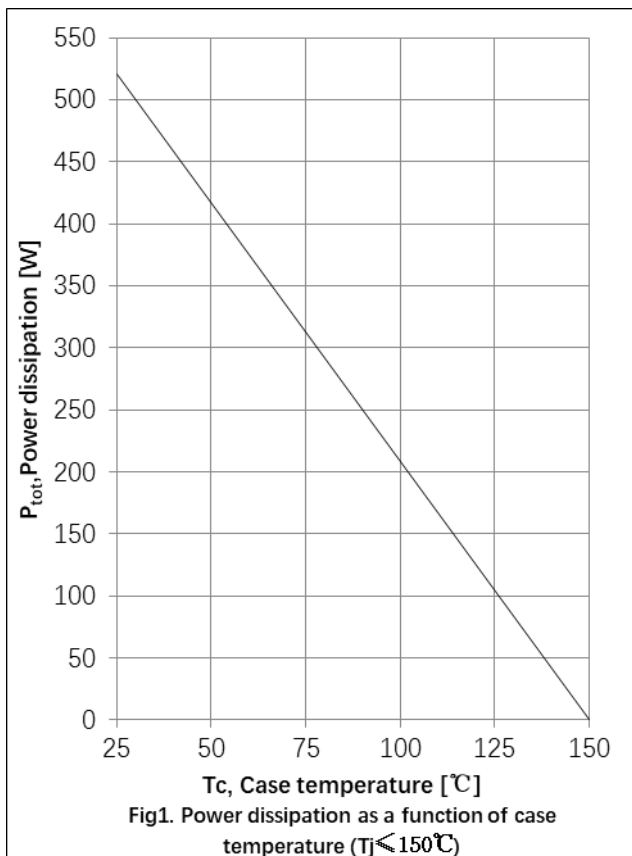


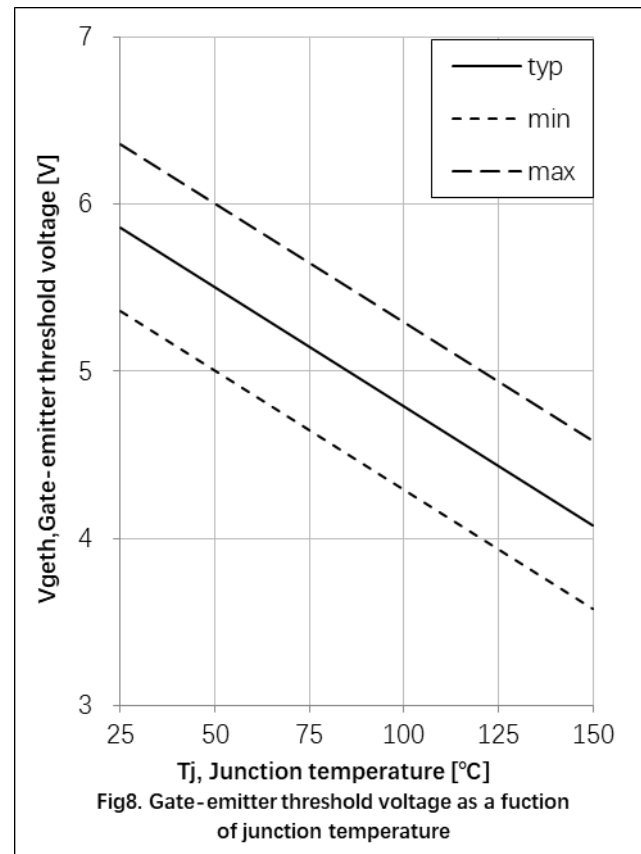
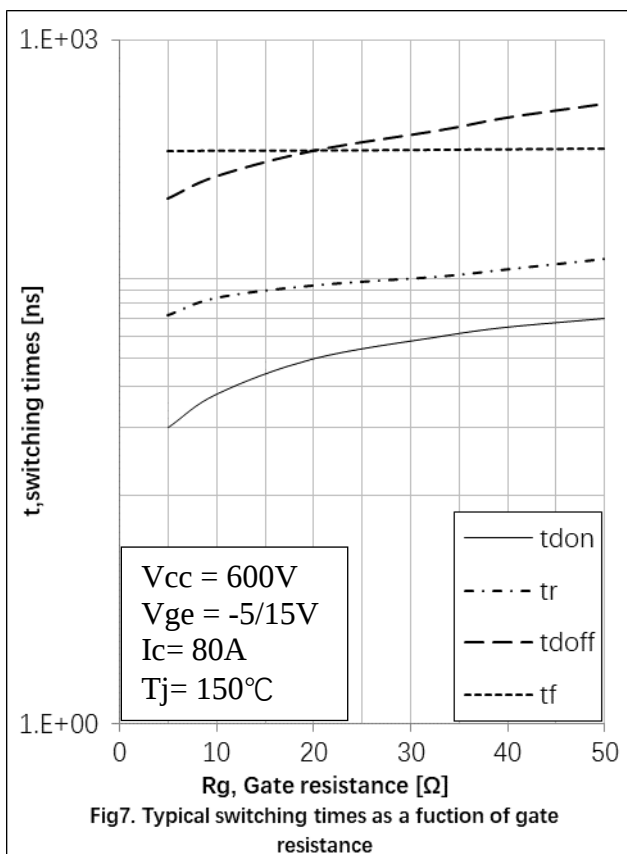
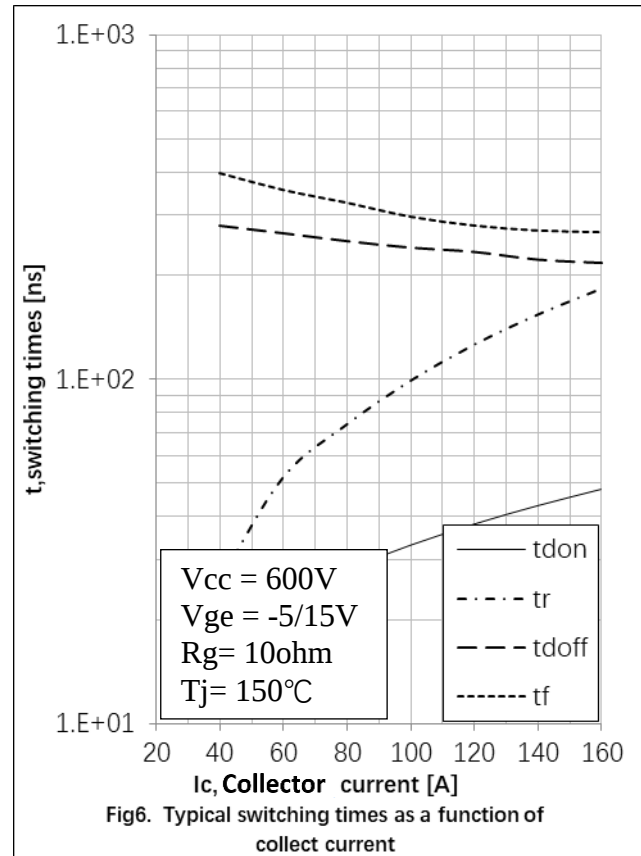
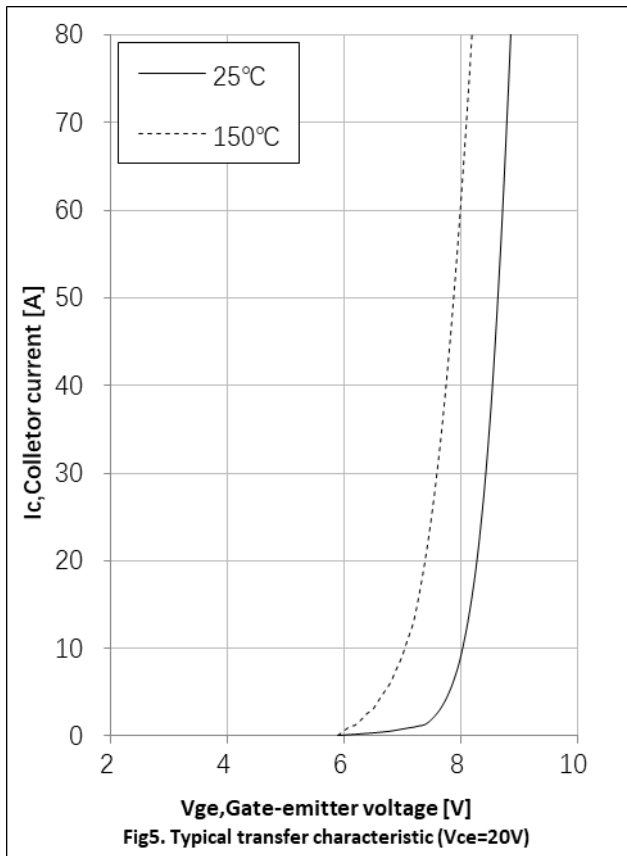
Switching Characteristic, Inductive Load

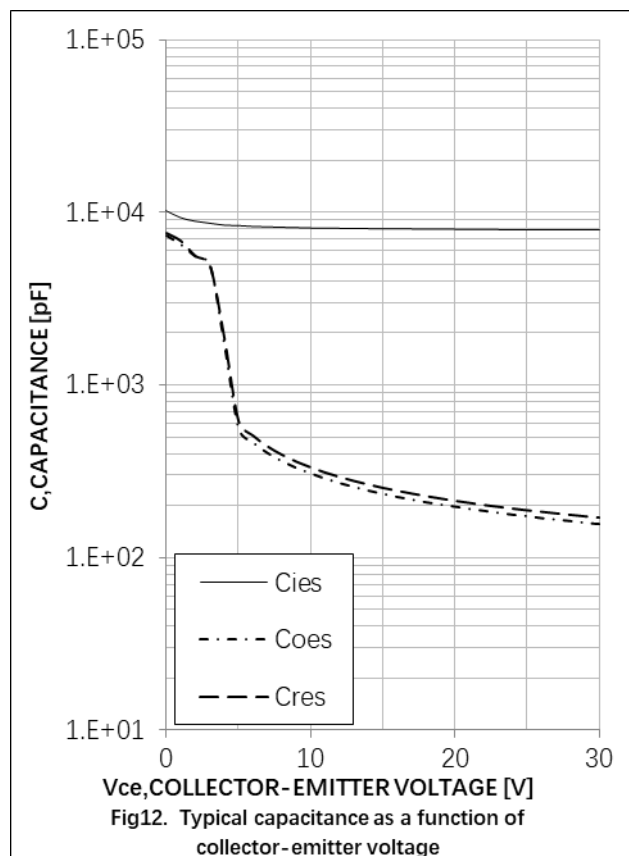
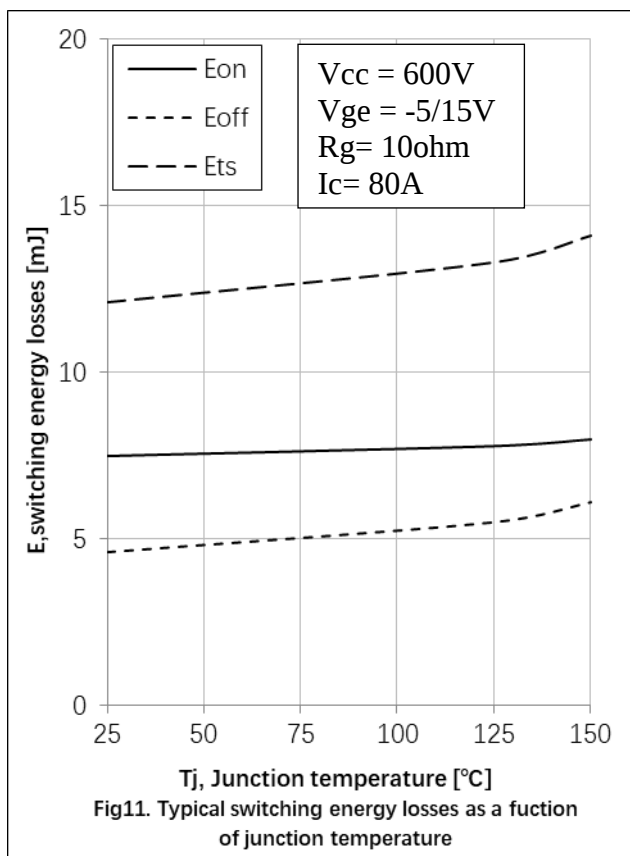
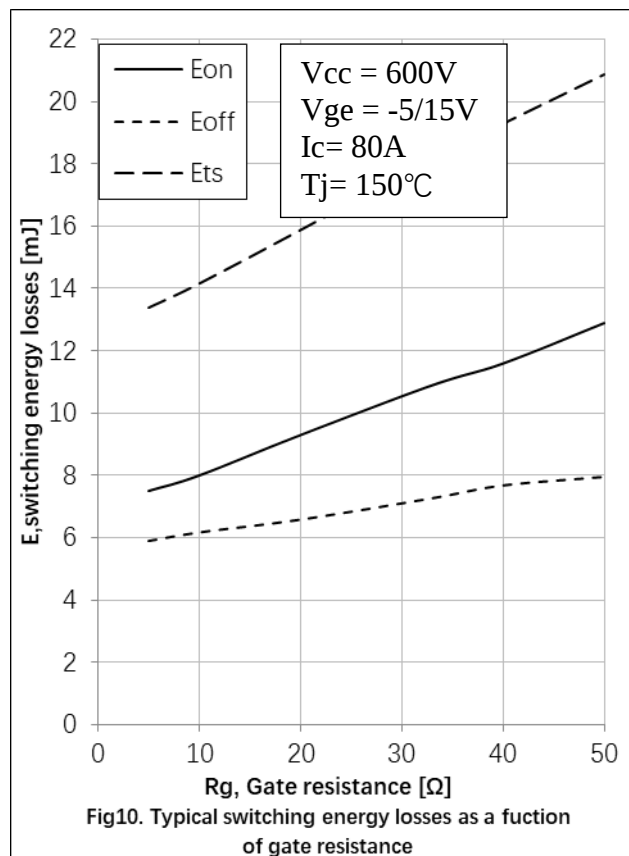
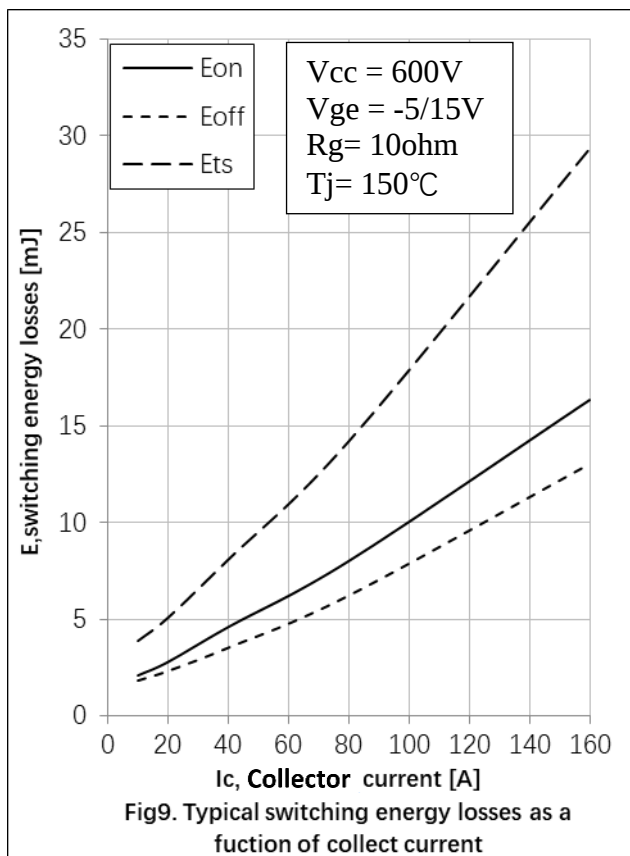
Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
Dynamic , at T _j = 25℃						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 600V, I _C =80A, V _{GE} = -5V~15V, R _g =10Ω	-	33	-	ns
Rise Time	t _r		-	85	-	ns
Turn-on Energy	E _{on}		-	7.5	-	mJ
Turn-off Delay Time	t _{d(off)}		-	231	-	ns
Fall Time	t _f		-	174	-	ns
Turn-off Energy	E _{off}		-	4.6	-	mJ
Dynamic , at T _j = 125℃						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 600V, I _C =80A, V _{GE} = -5V~15V, R _g =10Ω	-	30	-	ns
Rise Time	t _r		-	79	-	ns
Turn-on Energy	E _{on}		-	7.8	-	mJ
Turn-off Delay Time	t _{d(off)}		-	243	-	ns
Fall Time	t _f		-	263	-	ns
Turn-off Energy	E _{off}		-	5.5	-	mJ
Dynamic , at T _j = 150℃						
Turn-on Delay Time	t _{d(on)}	V _{CC} = 600V, I _C =80A, V _{GE} = -5V~15V, R _g =10Ω	-	28	-	ns
Rise Time	t _r		-	74	-	ns
Turn-on Energy	E _{on}		-	8.0	-	mJ
Turn-off Delay Time	t _{d(off)}		-	252	-	ns
Fall Time	t _f		-	325	-	ns
Turn-off Energy	E _{off}		-	6.2	-	mJ

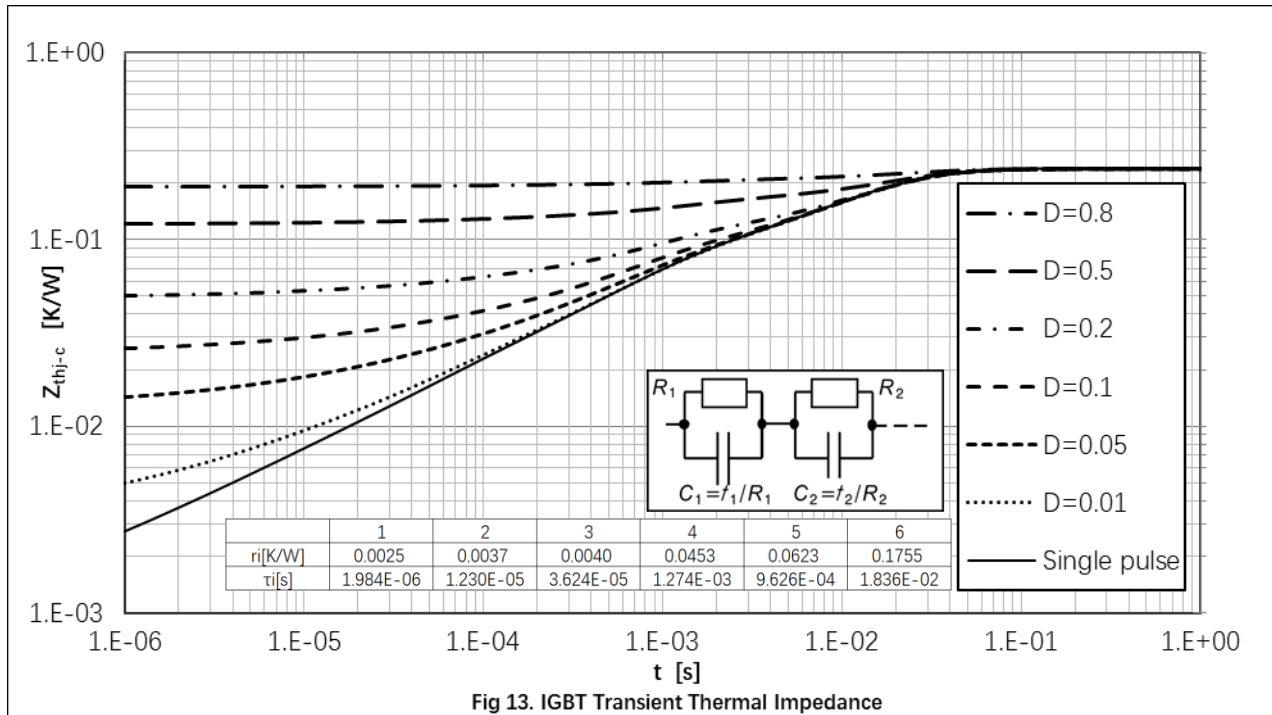
Thermal Resistance

Parameter	Symbol	Max. Value	Unit
IGBT Thermal Resistance, Junction - Case	R _{th(j-c)}	0.24	K/W
Thermal Resistance, Junction - Ambient	R _{th(j-a)}	40	K/W

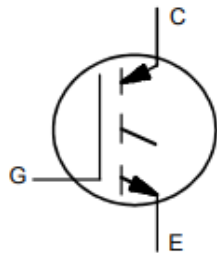




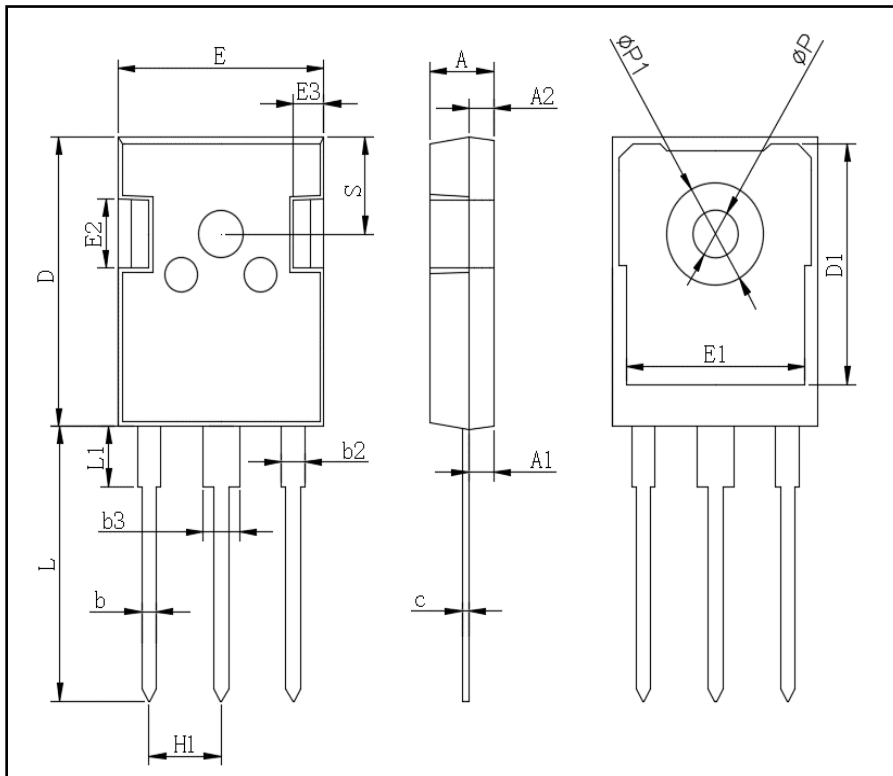




● Circuit Diagram



● Package Outline Information



TO-247AB		
Dim	Min	Max
A	4.80	5.20
A1	2.21	2.61
A2	1.85	2.15
b	1.0	1.4
b2	1.91	2.21
C	0.5	0.7
D	20.70	21.30
D1	16.25	16.85
E	15.50	16.10
E1	13.0	13.6
E2	4.80	5.20
E3	2.30	2.70
L	19.62	20.22
L1	-	4.30
Φ P	3.40	3.80
Φ P1	-	7.30
S	6.15TYP	
H1	5.44TYP	
b3	2.80	3.20



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